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Assistant Commissioner for Patents: Please print

1. Name of conveying party(ies):

Wen-Hao Liang
Chin-Jong Chan
Hsiu-Hsin Chung
Rueyway Lin

NRD
3-13-98

2. Name and address of receiving party(ies):

Winbond Electronics Corp.
No. 4, Creation Rd. III,
Science-Based Industrial Park
Hsinchu, Taiwan, R.O.C.

Additional name(s) attached? ☐ Yes ☒ NoAdditional names/addresses attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment
☐ Merger
☐ Security Agreement
☐ Change of Name
☐ Other:

Execution Date: **January 21, 1998, March 4, 1998,**
March 6, 1998

4. Application number(s) or patent number(s):

If this document is being filed with a new application, the execution date of the application is: **January 21, 1998,**
March 4, 1998, March 6, 1998

A. Patent Application No.(s):

B. Patent No.(s):

09/042,236

Additional numbers attached? ☐ Yes ☒ No

5. Name/address of party to whom correspondence concerning document should be mailed:

Eric L. Prah
Fish & Richardson P.C.
225 Franklin Street
Boston, MA 02110-2804

6. Total number of applications/patents involved: 1

7. Total fee (37 CFR 3.41): \$40

- ☒ Enclosed
☐ Authorized to charge deposit account

8. Deposit account number: 06-1050

If the fee above is being charged to deposit account, a duplicate copy of this cover sheet is attached. Please apply any additional charges, or any credits, to our Deposit Account No. 06-1050.

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9. Statement and signature: *To the best of my knowledge and belief, the foregoing information is true and correct and the attached is the original document.*

Eric L. Prah

Name of Person Signing

Signature

Date

March 13, 1998

Total number of pages including cover sheet, attachments, and document: 2 EM599471046US

Date of Deposit March 13, 1998

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PATENT
Justin McGovern
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01 FC:581 40.00 DP

ASSIGNMENT

WHEREAS, Wen-Hao LIANG, Chin-Jong CHAN, Hsiu-Hsin CHUNG, Rueyway LIN hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: BONDING PAD STRUCTURE FOR INTEGRATED CIRCUIT (III)

Filed: _____ Serial No. _____

Executed on: January 21, 1998, March 4, 1998 and March 5, 1998

WHEREAS, Winbond Electronics Corp. of No. 4, Creation Rd. III, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Wen-Hao Liang
Wen-Hao LIANG

Jan. 21, 1998
Date:

Chin-Jong Chan
Chin-Jong CHAN

Jan. 21, 1998
Date:

Hsiu-Hsin Chung
Hsiu-Hsin CHUNG

March 4, 1998
Date:

Rueyway Lin
Rueyway LIN

March 5, 1998
Date: